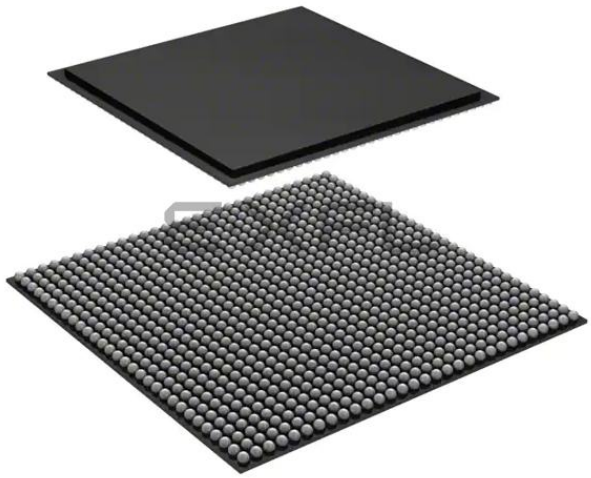
Lattice Semiconductor Corporation - LFE2-70SE-5FN900I Datasheet



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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	8500
Number of Logic Elements/Cells	68000
Total RAM Bits	1056768
Number of I/O	583
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	900-BBGA
Supplier Device Package	900-FPBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-70se-5fn900i

one clock is selected for each input register, pipeline register and output register. Similarly Clock enable (CE) and Reset (RST) are selected from their four respective sources (CE0, CE1, CE2, CE3 and RST0, RST1, RST2, RST3) at each input register, pipeline register and output register.

Signed and Unsigned with Different Widths

The DSP block supports different widths of signed and unsigned multipliers besides x9, x18 and x36 widths. For unsigned operands, unused upper data bits should be filled to create a valid x9, x18 or x36 operand. For signed two's complement operands, sign extension of the most significant bit should be performed until x9, x18 or x36 width is reached. Table 2-8 provides an example of this.

Table 2-8. Sign Extension Example

Number	Unsigned	Unsigned 9-bit	Unsigned 18-bit	Signed	Two's Complement Signed 9 Bits	Two's Complement Signed 18 Bits
+5	0101	000000101	000000000000000101	0101	000000101	000000000000000101
-6	N/A	N/A	N/A	1010	111111010	111111111111111010

OVERFLOW Flag from MAC

The sysDSP block provides an overflow output to indicate that the accumulator has overflowed. When two unsigned numbers are added and the result is a smaller number than the accumulator, "roll-over" is said to have occurred and an overflow signal is indicated. When two positive numbers are added with a negative sum and when two negative numbers are added with a positive sum, then the accumulator "roll-over" is said to have occurred and an overflow signal is indicated. Note that when overflow occurs the overflow flag is present for only one cycle. By counting these overflow pulses in FPGA logic, larger accumulators can be constructed. The conditions overflow signals for signed and unsigned operands are listed in Figure 2-27.

Figure 2-27. Accumulator Overflow/Underflow

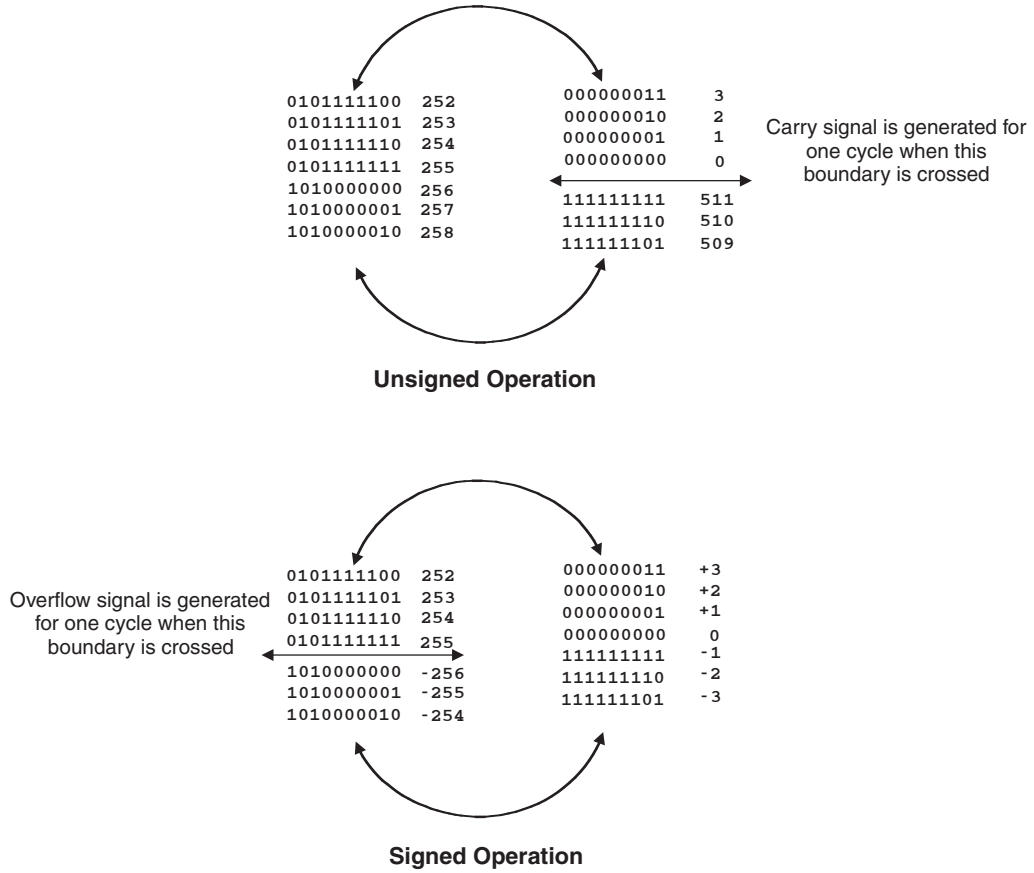
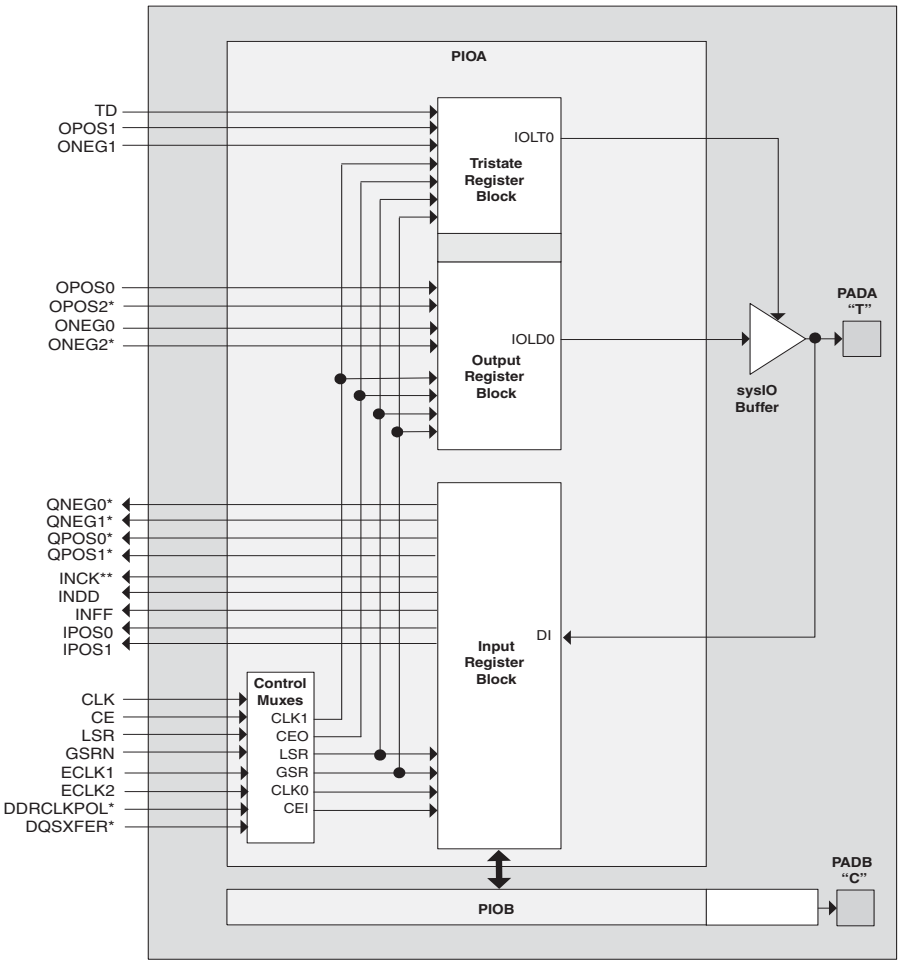


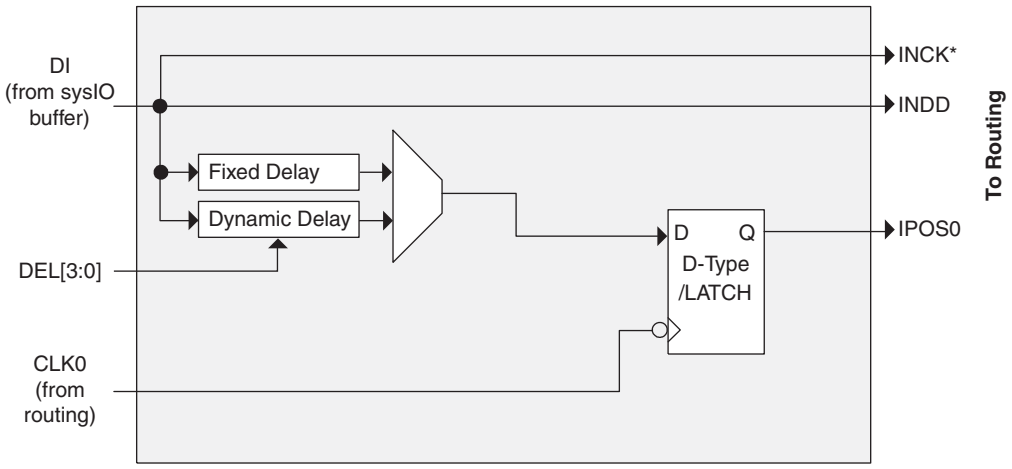
Figure 2-28. PIC Diagram



*Signals are available on left/right/bottom edges only.
** Selected blocks.

Two adjacent PIOs can be joined to provide a differential I/O pair (labeled as “T” and “C”) as shown in Figure 2-28. The PAD Labels “T” and “C” distinguish the two PIOs. Approximately 50% of the PIO pairs on the left and right edges of the device can be configured as true LVDS outputs. All I/O pairs can operate as inputs.

Figure 2-30. Input Register Block Top Edge



Note: Simplified version does not show CE and SET/RESET details.
*On selected blocks.

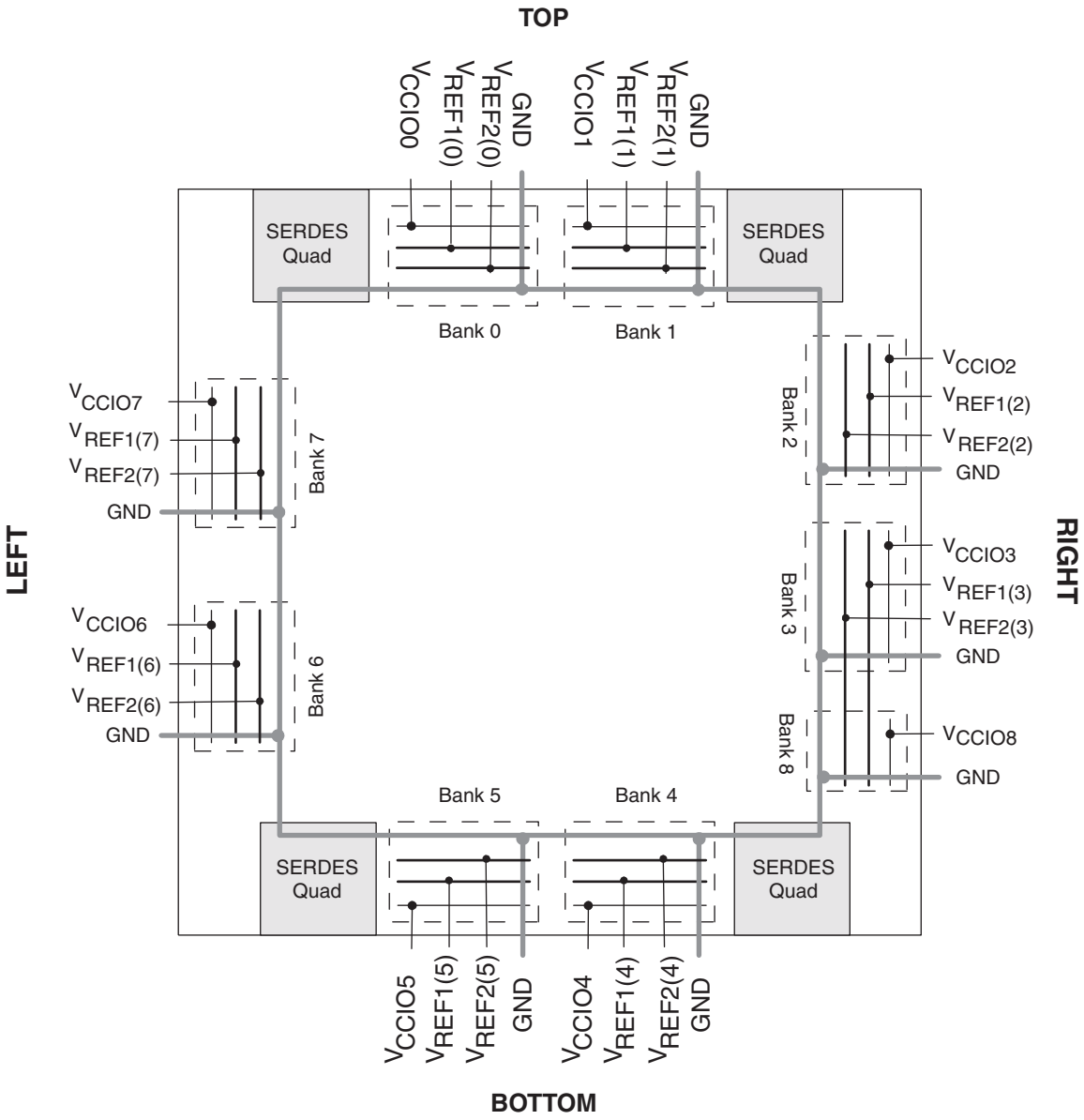
Output Register Block

The output register block provides the ability to register signals from the core of the device before they are passed to the sysI/O buffers. The blocks on the PIOs on the left, right and bottom contain a register for SDR operation that is combined with an additional latch for DDR operation. Figure 2-31 shows the diagram of the Output Register Block for PIOs on the left, right and the bottom edges. Figure 2-32 shows the diagram of the Output Register Block for PIOs on the top edge of the device.

In SDR mode, ONEG0 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured as a D-type or latch. In DDR mode, ONEG0 and OPOS0 are fed into registers on the positive edge of the clock. Then at the next clock cycle this registered OPOS0 is latched. A multiplexer running off the same clock selects the correct register for feeding to the output (D0).

By combining the output blocks of the complementary PIOs and sharing some registers from input blocks, a gearbox function can be implemented, that takes four data streams: ONEG0A, ONEG1A, ONEG1B and ONEG1B. Figure 2-32 shows the diagram using this gearbox function. For more information about this topic, please see information regarding additional documentation at the end of this data sheet.

Figure 2-38. LatticeECP2M Banks



LatticeECP2/M devices contain two types of sysI/O buffer pairs.

1. **Top (Bank 0 and Bank 1) sysI/O Buffer Pairs (Single-Ended Outputs Only)**
   The sysI/O buffer pairs in the top banks of the device consist of two single-ended output drivers and two sets of single-ended input buffers (both ratioed and referenced). One of the referenced input buffers can also be configured as a differential input.

   The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

2. **Bottom (Bank 4 and Bank 5) sysI/O Buffer Pairs (Single-Ended Outputs Only)**
   The sysI/O buffer pairs in the bottom banks of the device consist of two single-ended output drivers and two

sets of single-ended input buffers (both ratioed and referenced). One of the referenced input buffers can also be configured as a differential input.

The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

3. **Left and Right (Banks 2, 3, 6 and 7) sysI/O Buffer Pairs (50% Differential and 100% Single-Ended Outputs)**
   The sysI/O buffer pairs in the left and right banks of the device consist of two single-ended output drivers, two sets of single-ended input buffers (both ratioed and referenced) and one differential output driver. One of the referenced input buffers can also be configured as a differential input. In these banks the two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential I/O, and the comp (complementary) pad is associated with the negative side of the differential I/O.

   LVDS differential output drivers are available on 50% of the buffer pairs on the left and right banks.

4. **Bank 8 sysI/O Buffer Pairs (Single-Ended Outputs, Only on Shared Pins When Not Used by Configuration)**
   The sysI/O buffers in Bank 8 consist of single-ended output drivers and single-ended input buffers (both ratioed and referenced). The referenced input buffer can also be configured as a differential input.

   The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

In LatticeECP2 devices, only the I/Os on the bottom banks have programmable PCI clamps. In LatticeECP2M devices, the I/Os on the left and bottom banks have programmable PCI clamps.

Typical sysI/O I/O Behavior During Power-up

The internal power-on-reset (POR) signal is deactivated when V_{CC}, V_{CCIO8} and V_{CCAUX} have reached satisfactory levels. After the POR signal is deactivated, the FPGA core logic becomes active. It is the user’s responsibility to ensure that all other V_{CCIO} banks are active with valid input logic levels to properly control the output logic states of all the I/O banks that are critical to the application. For more information about controlling the output logic state with valid input logic levels during power-up in LatticeECP2/M devices, see the list of additional technical documentation at the end of this data sheet.

The V_{CC} and V_{CCAUX} supply the power to the FPGA core fabric, whereas the V_{CCIO} supplies power to the I/O buffers. In order to simplify system design while providing consistent and predictable I/O behavior, it is recommended that the I/O buffers be powered-up prior to the FPGA core fabric. V_{CCIO} supplies should be powered-up before or together with the V_{CC} and V_{CCAUX} supplies.

Prior to and throughout programming of the FPGA, the I/O of the device have a weak-pullup resistor to V_{CCIO} on the input buffer and the output buffer is tri-stated. A pullup to V_{CCIO} is present on the input until the user programs the input differently in the FPGA design. See the DC Electrical Characteristics table of this data sheet. The pullup value will be between 20-30K ohms based on the V_{CCIO} voltage supplied on the board. This pullup will also remain active if the design does not use a particular I/O.

Supported sysI/O Standards

The LatticeECP2/M sysI/O buffer supports both single-ended and differential standards. Single-ended standards can be further subdivided into LVCMOS, LVTTL and other standards. The buffers support the LVTTL, LVCMOS 1.2V, 1.5V, 1.8V, 2.5V and 3.3V standards. In the LVCMOS and LVTTL modes, the buffer has individual configuration options for drive strength, bus maintenance (weak pull-up, weak pull-down, or a bus-keeper latch) and open drain. Other single-ended standards supported include SSTL and HSTL. Differential standards supported include LVDS, MLVDS, BLVDS, LVPECL, RSDS, differential SSTL and differential HSTL. Tables 2-13 and 2-14 show the I/

BLVDS

The LatticeECP2/M devices support the BLVDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel external resistor across the driver outputs. BLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-2 is one possible solution for bi-directional multi-point differential signals.

Figure 3-2. BLVDS Multi-point Output Example

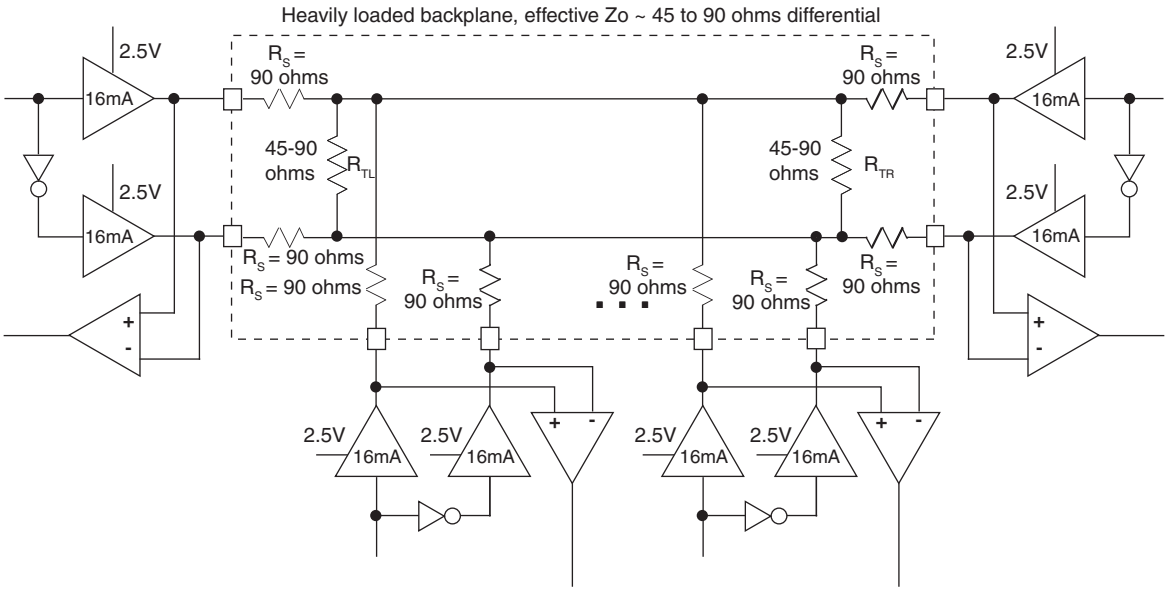


Table 3-3. BLVDS DC Conditions[1]

Over Recommended Operating Conditions

Parameter	Description	Typical		Units
		Zo = 45Ω	Zo = 90Ω	
V_{CCIO}	Output Driver Supply (+/- 5%)	2.50	2.50	V
Z_{OUT}	Driver Impedance	10.00	10.00	Ω
R_S	Driver Series Resistor (+/- 1%)	90.00	90.00	Ω
R_{TL}	Driver Parallel Resistor (+/- 1%)	45.00	90.00	Ω
R_{TR}	Receiver Termination (+/- 1%)	45.00	90.00	Ω
V_{OH}	Output High Voltage	1.38	1.48	V
V_{OL}	Output Low Voltage	1.12	1.02	V
V_{OD}	Output Differential Voltage	0.25	0.46	V
V_{CM}	Output Common Mode Voltage	1.25	1.25	V
I_{DC}	DC Output Current	11.24	10.20	mA

1. For input buffer, see LVDS table.

RSDS

The LatticeECP2/M devices support differential RSDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The RSDS input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-4 is one possible solution for RSDS standard implementation. Resistor values in Figure 3-4 are industry standard values for 1% resistors.

Figure 3-4. RSDS (Reduced Swing Differential Signaling)

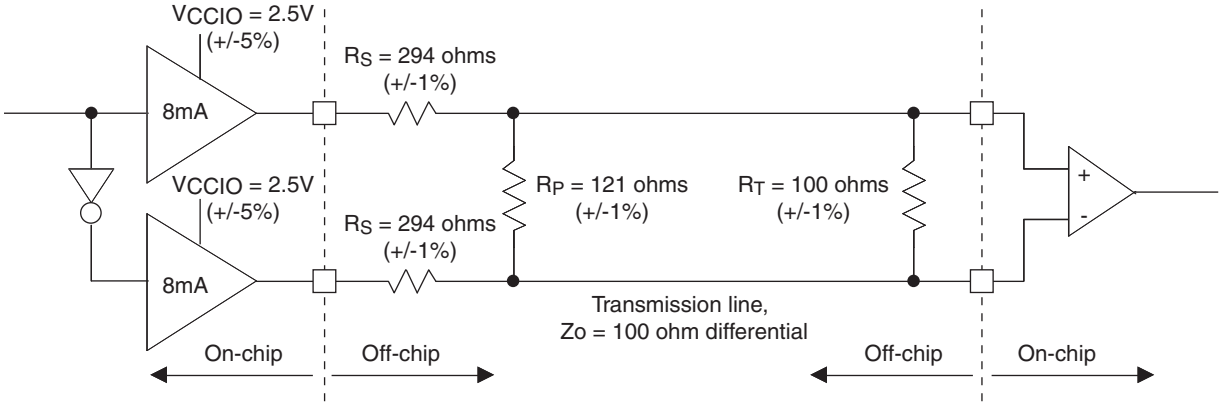


Table 3-5. RSDS DC Conditions[1]

Over Recommended Operating Conditions

Parameter	Description	Typical	Units
V_{CCIO}	Output Driver Supply (+/-5%)	2.50	V
Z_{OUT}	Driver Impedance	20	Ω
R_S	Driver Series Resistor (+/-1%)	294	Ω
R_P	Driver Parallel Resistor (+/-1%)	121	Ω
R_T	Receiver Termination (+/-1%)	100	Ω
V_{OH}	Output High Voltage	1.35	V
V_{OL}	Output Low Voltage	1.15	V
V_{OD}	Output Differential Voltage	0.20	V
V_{CM}	Output Common Mode Voltage	1.25	V
Z_{BACK}	Back Impedance	101.5	Ω
I_{DC}	DC Output Current	3.66	mA

1. For input buffer, see LVDS table.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]DQS[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQS, num = ball function number.
[LOC]DQ[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQ, associated DQS number.
Test and Programming (Dedicated Pins)		
TMS	I	Test Mode Select input, used to control the 1149.1 state machine. Pull-up is enabled during configuration.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine. No pull-up enabled.
TDI	I	Test Data in pin. Used to load data into device using 1149.1 state machine. After power-up, this TAP port can be activated for configuration by sending appropriate command. (Note: once a configuration port is selected it is locked. Another configuration port cannot be selected until the power-up sequence). Pull-up is enabled during configuration.
TDO	O	Output pin. Test Data Out pin used to shift data out of a device using 1149.1.
VCCJ	—	Power supply pin for JTAG Test Access Port.
Configuration Pads (Used During sysCONFIG)		
CFG[2:0]	I	Mode pins used to specify configuration mode values latched on rising edge of INITN. During configuration, a pull-up is enabled. These are dedicated pins.
INITN	I/O	Open Drain pin. Indicates the FPGA is ready to be configured. During configuration, a pull-up is enabled. It is a dedicated pin.
PROGRAMN	I	Initiates configuration sequence when asserted low. This pin always has an active pull-up. This is a dedicated pin.
DONE	I/O	Open Drain pin. Indicates that the configuration sequence is complete, and the startup sequence is in progress. This is a dedicated pin.
CCLK	I/O	Configuration Clock for configuring an FPGA in sysCONFIG mode.
BUSY/SISPI	I/O	Read control command in SPI or SPIm mode.
CSN	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
CS1N	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
WRITEN	I	Write Data on Parallel port (active low).
D[0]/SPIFASTN	I/O	sysCONFIG Port Data I/O for Parallel mode. sysCONFIG Port Data I/O for SPI or SPIm. When using the SPI or SPIm mode, this pin should either be tied high or low, must not be left floating.
D[1:6]	I/O	sysCONFIG Port Data I/O for Parallel
D[7]/SPID0	I/O	sysCONFIG Port Data I/O for Parallel, SPI, SPIm
DOUT/CSON	O	Output for serial configuration data (rising edge of CCLK) when using sysCONFIG port.
DI/CSSPI0N	I/O	Input for serial configuration data (clocked with CCLK) when using sysCONFIG port. During configuration, a pull-up is enabled. Output when used in SPI/SPIm modes.
Dedicated SERDES Signals[1, 2, 3]		
[LOC]_SQ_VCCAUX33	—	Termination resistor switching power (3.3V). This pin must be tied to 3.3V even if the quad is unused.
[LOC]_SQ_REFCLKN	I	Negative Reference Clock Input
[LOC]_SQ_REFCLKP	I	Positive Reference Clock Input
[LOC]_SQ_VCCP	—	PLL and Reference clock buffer power (1.2V). This pin must be tied to 1.2V even if the quad is unused.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
91	PR20B	3	RLM0_GPLLC_IN_A**	C (LVDS)*	PR20B	3	RLM0_GPLLC_IN_A**	C (LVDS)*
92	PR20A	3	RLM0_GPLLT_IN_A**	T (LVDS)*	PR20A	3	RLM0_GPLLT_IN_A**	T (LVDS)*
93	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
94	VCC	-			VCC	-		
95	GND	-			GND	-		
96	PR17B	3	RLM0_GDLLC_IN_A**	C (LVDS)*	PR17B	3	RLM0_GDLLC_IN_A**	C (LVDS)*
97	PR17A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR17A	3	RLM0_GDLLT_IN_A**	T (LVDS)*
98	PR16B	3	VREF2_3	C	PR16B	3	VREF2_3	C
99	PR16A	3	VREF1_3	T	PR16A	3	VREF1_3	T
100	PR15B	3	PCLKC3_0	C (LVDS)*	PR15B	3	PCLKC3_0	C (LVDS)*
101	PR15A	3	PCLKT3_0	T (LVDS)*	PR15A	3	PCLKT3_0	T (LVDS)*
102	VCC	-			VCC	-		
103	PR13B	2	PCLKC2_0/RDQ10	C	PR13B	2	PCLKC2_0/RDQ10	C
104	PR13A	2	PCLKT2_0/RDQ10	T	PR13A	2	PCLKT2_0/RDQ10	T
105	GND	-			GND	-		
106	VCCIO2	2			VCCIO2	2		
107	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*
108	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*
109	PT28B	1	VREF2_1	C	PT55B	1	VREF2_1	C
110	PT28A	1	VREF1_1	T	PT55A	1	VREF1_1	T
111	PT26B	1		C	PT54B	1		C
112	PT26A	1		T	PT54A	1		T
113	PT24B	1		C	PT52B	1		C
114	PT24A	1		T	PT52A	1		T
115	PT22B	1		C	PT50B	1		C
116	PT22A	1		T	PT50A	1		T
117	VCCIO1	1			VCCIO1	1		
118	PT20B	1		C	PT48B	1		C
119	PT20A	1		T	PT48A	1		T
120	GND	-			GND	-		
121	PT18B	1		C	PT44B	1		C
122	PT18A	1		T	PT44A	1		T
123	PT16A	1			PT40B	1		C
124	NC	1			PT40A	1		T
125	PT14B	1		C	PT34B	1		C
126	PT14A	1		T	PT34A	1		T
127	NC	1			NC	1		
128	VCC	-			VCC	-		
129	PT12B	1	PCLKC1_0	C	PT30B	1	PCLKC1_0	C
130	PT12A	1	PCLKT1_0	T	PT30A	1	PCLKT1_0	T
131	PT10B	0	PCLKC0_0	C	PT28B	0	PCLKC0_0	C
132	XRES	0			XRES	0		
133	GND	-			GND	-		
134	PT10A	0	PCLKT0_0	T	PT28A	0	PCLKT0_0	T
135	VCC	-			VCC	-		

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
L11	L11	PB61B	4	BDQ60	C
T13	T13	PB62A	4	BDQ60	T
R13	R13	PB63A	4	BDQ60	T
VCCIO	VCCIO	VCCIO4	4		
T14	T14	PB62B	4	BDQ60	C
P13	P13	PB63B	4	BDQ60	C
GND	GND	GNDIO4	-		
N12	N12	PB64A	4	VREF2_4/BDQ60	T
M12	M12	PB64B	4	VREF1_4/BDQ60	C
R15	R15	CFG2	8		
N14	N14	CFG1	8		
N13	N13	PROGRAMN	8		
N15	N15	CFG0	8		
P15	P15	PR44B	8	WRITEN	C
L12	L12	INITN	8		
N16	N16	PR43B	8	CSN	C
GND	GND	GNDIO8	-		
R14	R14	CCLK	8		
P14	P14	PR44A	8	CS1N	T
M13	M13	DONE	8		
R16	R16	PR42B	8	D1	C
VCCIO	VCCIO	VCCIO8	8		
M16	M16	PR43A	8	D0/SPIFASTN	T
P16	P16	PR42A	8	D2	T
L15	L15	PR41B	8	D3	C
GND	GND	GNDIO8	-		
L14	L14	PR40A	8	D6	T
L16	L16	PR41A	8	D4	T
L10	L10	PR39B	8	D7/SPID0	C
L13	L13	PR40B	8	D5	C
VCCIO	VCCIO	VCCIO8	8		
K11	K11	PR39A	8	DI/CSSPI0N	T
K14	K14	PR38B	8	DOUT/CSON	C
K13	K13	PR38A	8	BUSY/SISPI	T
GND	GND	GNDIO8	-		
K15	K15	PR31B	3	RLM0_GPLLC_FB_A/RDQ34	C
VCCIO	VCCIO	VCCIO3	3		
K16	K16	PR31A	3	RLM0_GPLLT_FB_A/RDQ34	T
GND	GND	GNDIO3	-		
J16	J16	PR30B	3	RLM0_GPLLC_IN_A**/RDQ34	C (LVDS)*
J15	J15	PR30A	3	RLM0_GPLLT_IN_A**/RDQ34	T (LVDS)*
J14	J14	RLM0_PLLCAP	3		

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
C8	PT29B	0		C	PT38B	0		C
D8	PT29A	0		T	PT38A	0		T
GNDIO	GNDIO0	-			GNDIO0	0		
D10	PT27B	0		C	PT36B	0		C
E10	PT27A	0		T	PT36A	0		T
C7	PT26B	0		C	PT35B	0		C
C6	PT26A	0		T	PT35A	0		T
VCCIO	VCCIO0	0			VCCIO	0		
B6	PT25B	0		C	PT34B	0		C
B5	PT25A	0		T	PT34A	0		T
F10	PT24B	0		C	PT33B	0		C
D9	PT24A	0		T	PT33A	0		T
GNDIO	GNDIO0	-			GNDIO0	0		
F9	PT23B	0		C	PT32B	0		C
E9	PT23A	0		T	PT32A	0		T
A5	PT22B	0		C	PT31B	0		C
A4	PT22A	0		T	PT31A	0		T
VCCIO	VCCIO0	0			VCCIO	0		
A3	PT21B	0		C	PT30B	0		C
A2	PT21A	0		T	PT30A	0		T
G8	PT20B	0		C	PT29B	0		C
E8	PT20A	0		T	PT29A	0		T
GNDIO	GNDIO0	-			GNDIO0	0		
VCCIO	VCCIO0	0			VCCIO	0		
C3	PT10B	0		C	PT10B	0		C
B3	PT10A	0		T	PT10A	0		T
GNDIO	GNDIO0	-			GNDIO0	0		
F8	PT9B	0		C	PT9B	0		C
D7	PT9A	0		T	PT9A	0		T
E7	PT8B	0		C	PT8B	0		C
VCCIO	VCCIO0	0			VCCIO	0		
F7	PT8A	0		T	PT8A	0		T
D5	PT7B	0		C	PT7B	0		C
D6	PT7A	0		T	PT7A	0		T
D4	PT6B	0		C	PT6B	0		C
C4	PT6A	0		T	PT6A	0		T
GNDIO	GNDIO0	-			GNDIO0	0		
B2	PT5B	0		C	PT5B	0		C
B1	PT5A	0		T	PT5A	0		T
J7	PT4B	0		C	PT4B	0		C
VCCIO	VCCIO0	0			VCCIO	0		
H7	PT4A	0		T	PT4A	0		T
D3	PT3B	0		C	PT3B	0		C
C2	PT3A	0		T	PT3A	0		T
D1	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C
C1	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
U21	CS1N***	8		
U17	CSN***	8		
U16	D0/SPIFASTN***	8		
VCCIO	VCCIO8	8		
T16	D1***	8		
T17	D2***	8		
T22	D3***	8		
GNDIO	GNDIO8	-		
R22	D4***	8		
T15	D5***	8		
R17	D6***	8		
T20	D7/SPID0***	8		
VCCIO	VCCIO8	8		
T21	DI/CSSPI0N***	8		
R21	DOUT/CSON/CSSPI1N***	8		
R20	BUSY/SISPI***	8		
R16	RLM0_PLLCAP	3		
R18	PR65B	3	RLM0_GDLLC_FB_A	C
GNDIO	GNDIO3	-		
R19	PR65A	3	RLM0_GDLLT_FB_A	T
P22	PR64B	3	RLM0_GDLLC_IN_A**	C (LVDS)*
P21	PR64A	3	RLM0_GDLLT_IN_A**	T (LVDS)*
P16	PR63B	3	RLM0_GPLLC_IN_A**	C
VCCIO	VCCIO3	3		
P17	PR63A	3	RLM0_GPLLT_IN_A**	T
P20	PR62B	3	RLM0_GPLLC_FB_A	C (LVDS)*
P19	PR62A	3	RLM0_GPLLT_FB_A	T (LVDS)*
GNDIO	GNDIO3	-		
VCCIO	VCCIO3	3		
P18	PR55B	3	RDQ52	C
N16	PR55A	3	RDQ52	T
GNDIO	GNDIO3	-		
N22	PR54B	3	RDQ52	C (LVDS)*
N21	PR54A	3	RDQ52	T (LVDS)*
N17	PR53B	3	RDQ52	C
N18	PR53A	3	RDQ52	T
VCCIO	VCCIO3	3		
M22	PR52B	3	RDQ52	C (LVDS)*
M21	PR52A	3	RDQS52	T (LVDS)*
M16	PR51B	3	RDQ52	C
GNDIO	GNDIO3	-		
M17	PR51A	3	RDQ52	T
M20	PR50B	3	RDQ52	C (LVDS)*

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
J11	VCC	-		
J12	VCC	-		
J13	VCC	-		
K14	VCC	-		
K9	VCC	-		
L14	VCC	-		
L9	VCC	-		
M14	VCC	-		
M9	VCC	-		
N14	VCC	-		
N9	VCC	-		
P10	VCC	-		
P11	VCC	-		
P12	VCC	-		
P13	VCC	-		
B5	VCCIO0	0		
B9	VCCIO0	0		
E7	VCCIO0	0		
H9	VCCIO0	0		
D13	VCCIO1	1		
E16	VCCIO1	1		
H14	VCCIO1	1		
E21	VCCIO2	2		
G18	VCCIO2	2		
J15	VCCIO2	2		
K19	VCCIO2	2		
N19	VCCIO3	3		
P15	VCCIO3	3		
T18	VCCIO3	3		
V21	VCCIO3	3		
AA18	VCCIO4	4		
R14	VCCIO4	4		
V16	VCCIO4	4		
W13	VCCIO4	4		
AA5	VCCIO5	5		
R9	VCCIO5	5		
V7	VCCIO5	5		
W10	VCCIO5	5		
N4	VCCIO6	6		
P8	VCCIO6	6		
T5	VCCIO6	6		
V2	VCCIO6	6		
E2	VCCIO7	7		

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L5	PL23A	7	LDQ27	T (LVDS)*	PL33A	7	LDQ37	T (LVDS)*
L4	PL23B	7	LDQ27	C (LVDS)*	PL33B	7	LDQ37	C (LVDS)*
N9	PL24A	7	LDQ27	T	PL34A	7	LDQ37	T
N7	PL24B	7	LDQ27	C	PL34B	7	LDQ37	C
K2	PL25A	7	LDQ27	T (LVDS)*	PL35A	7	LDQ37	T (LVDS)*
K1	PL25B	7	LDQ27	C (LVDS)*	PL35B	7	LDQ37	C (LVDS)*
P9	PL26A	7	LDQ27	T	PL36A	7	LDQ37	T
P7	PL26B	7	LDQ27	C	PL36B	7	LDQ37	C
GNDIO	GNDIO7	-			GNDIO7	-		
M6	PL27A	7	LDQS27	T (LVDS)*	PL37A	7	LDQS37	T (LVDS)*
M5	PL27B	7	LDQ27	C (LVDS)*	PL37B	7	LDQ37	C (LVDS)*
N5	PL28A	7	LDQ27	T	PL38A	7	LDQ37	T
N6	PL28B	7	LDQ27	C	PL38B	7	LDQ37	C
M4	PL29A	7	LDQ27	T (LVDS)*	PL39A	7	LDQ37	T (LVDS)*
M3	PL29B	7	LDQ27	C (LVDS)*	PL39B	7	LDQ37	C (LVDS)*
P6	PL30A	7	LDQ27	T	PL40A	7	LDQ37	T
GNDIO	GNDIO7	-			GNDIO7	-		
P8	PL30B	7	LDQ27	C	PL40B	7	LDQ37	C
L3	PL32A	7	LUM3_SPLLT_IN_A/LDQ36	T (LVDS)*	PL42A	7	LUM3_SPLLT_IN_A/LDQ46	T (LVDS)*
L2	PL32B	7	LUM3_SPLLC_IN_A/LDQ36	C (LVDS)*	PL42B	7	LUM3_SPLLC_IN_A/LDQ46	C (LVDS)*
P5	PL33A	7	LUM3_SPLLT_FB_A/LDQ36	T	PL43A	7	LUM3_SPLLT_FB_A/LDQ46	T
P4	PL33B	7	LUM3_SPLLC_FB_A/LDQ36	C	PL43B	7	LUM3_SPLLC_FB_A/LDQ46	C
L1	PL34A	7	LDQ36	T (LVDS)*	PL44A	7	LDQ46	T (LVDS)*
M2	PL34B	7	LDQ36	C (LVDS)*	PL44B	7	LDQ46	C (LVDS)*
R5	PL35A	7	LDQ36	T	PL45A	7	LDQ46	T
R4	PL35B	7	LDQ36	C	PL45B	7	LDQ46	C
GNDIO	GNDIO7	-			GNDIO7	-		
M1	PL36A	7	LDQS36	T (LVDS)*	PL46A	7	LDQS46	T (LVDS)*
N2	PL36B	7	LDQ36	C (LVDS)*	PL46B	7	LDQ46	C (LVDS)*
R8	PL37A	7	LDQ36	T	PL47A	7	LDQ46	T
T9	PL37B	7	LDQ36	C	PL47B	7	LDQ46	C
P3	PL38A	7	LDQ36	T (LVDS)*	PL48A	7	LDQ46	T (LVDS)*
P2	PL38B	7	LDQ36	C (LVDS)*	PL48B	7	LDQ46	C (LVDS)*
N1	PL39A	7	PCLKT7_0/LDQ36	T	PL49A	7	PCLKT7_0/LDQ46	T
GNDIO	GNDIO7	-			GNDIO7	-		
P1	PL39B	7	PCLKC7_0/LDQ36	C	PL49B	7	PCLKC7_0/LDQ46	C
T5	PL41A	6	PCLKT6_0	T (LVDS)*	PL51A	6	PCLKT6_0/LDQ55	T (LVDS)*
T4	PL41B	6	PCLKC6_0	C (LVDS)*	PL51B	6	PCLKC6_0/LDQ55	C (LVDS)*
U7	PL42A	6	VREF2_6	T	PL52A	6	VREF2_6/LDQ55	T
T8	PL42B	6	VREF1_6	C	PL52B	6	VREF1_6/LDQ55	C
R3	PL43A	6		T (LVDS)*	PL53A	6	LDQ55	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
R2	PL43B	6		C (LVDS)*	PL53B	6	LDQ55	C (LVDS)*
R1	PL44A	6		T	PL54A	6	LDQ55	T
T1	PL44B	6		C	PL54B	6	LDQ55	C
GNDIO	GNDIO6	-			GNDIO6	-		
-	-	-			VCCIO6	6		
T3	PL45A	6	LLM3_SPLLT_IN_A	T (LVDS)*	PL57A	6	LLM3_SPLLT_IN_A/LDQ55	T (LVDS)*

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
E13	PT28A	0		T	PT37A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
GNDIO	GNDIO0	-			GNDIO0	-		
J12	PT5B	0		C	PT31B	0		C
GNDIO	GNDIO0	-			-	-		
VCCIO	VCCIO0	0			VCCIO0	0		
H10	PT5A	0		T	PT31A	0		T
E12	PT4B	0		C	PT30B	0		C
D11	PT4A	0		T	PT30A	0		T
H11	PT3B	0		C	PT29B	0		C
F11	PT3A	0		T	PT29A	0		T
C13	VCC	-			ULC_SQ_VCCRX0	11		
A12	PT19A	0		T	ULC_SQ_HDINP0	11		T
B13	NC	-			ULC_SQ_VCCIB0	11		
B12	PT19B	0		C	ULC_SQ_HDINN0	11		C
C10	VCC	-			ULC_SQ_VCCTX0	11		
A9	PT17A	0		T	ULC_SQ_HDOUTP0	11		T
A10	NC	-			ULC_SQ_VCCOB0	11		
B9	PT17B	0		C	ULC_SQ_HDOUTN0	11		C
C9	VCC	-			ULC_SQ_VCCTX1	11		
B8	PT18B	0		C	ULC_SQ_HDOUTN1	11		C
C8	NC	-			ULC_SQ_VCCOB1	11		
A8	PT18A	0		T	ULC_SQ_HDOUTP1	11		T
C12	VCC	-			ULC_SQ_VCCRX1	11		
B11	PT16B	0		C	ULC_SQ_HDINN1	11		C
C11	NC	-			ULC_SQ_VCCIB1	11		
A11	PT16A	0		T	ULC_SQ_HDINP1	11		T
B7	VCCAUX	-			ULC_SQ_VCCAUX33	11		
E7	PT15B	0		C	ULC_SQ_REFCLKN	11		C
D7	PT15A	0		T	ULC_SQ_REFCLKP	11		T
C7	VCC	-			ULC_SQ_VCCP	11		
A3	PT12A	0		T	ULC_SQ_HDINP2	11		T
C3	NC	-			ULC_SQ_VCCIB2	11		
B3	PT12B	0		C	ULC_SQ_HDINN2	11		C
C2	VCC	-			ULC_SQ_VCCRX2	11		
A6	PT14A	0		T	ULC_SQ_HDOUTP2	11		T
C6	NC	-			ULC_SQ_VCCOB2	11		
B6	PT14B	0		C	ULC_SQ_HDOUTN2	11		C
C5	VCC	-			ULC_SQ_VCCTX2	11		
B5	PT13B	0		C	ULC_SQ_HDOUTN3	11		C
A4	NC	-			ULC_SQ_VCCOB3	11		
A5	PT13A	0		T	ULC_SQ_HDOUTP3	11		T
C4	VCC	-			ULC_SQ_VCCTX3	11		
B2	PT11B	0		C	ULC_SQ_HDINN3	11		C
B1	NC	-			ULC_SQ_VCCIB3	11		
A2	PT11A	0		T	ULC_SQ_HDINP3	11		T
C1	VCC	-			ULC_SQ_VCCRX3	11		
L12	VCC	-			VCC	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
AF11	PB62B	5	PCLKC5_0/BDQ60	C
VCCIO	VCCIO5	5		
GNDIO	GNDIO5	-		
AJ14	PB67A	4	PCLKT4_0/BDQ69	T
VCCIO	VCCIO4	4		
AK14	PB67B	4	PCLKC4_0/BDQ69	C
AK15	PB68A	4	VREF2_4/BDQ69	T
AK16	PB68B	4	VREF1_4/BDQ69	C
AF18	PB69A	4	BDQS69	T
GNDIO	GNDIO4	-		
AD16	PB69B	4	BDQ69	C
AJ15	PB70A	4	BDQ69	T
AG16	PB70B	4	BDQ69	C
AE17	PB71A	4	BDQ69	T
VCCIO	VCCIO4	4		
AC17	PB71B	4	BDQ69	C
AH16	PB72A	4	BDQ69	T
AK17	PB72B	4	BDQ69	C
AG20	PB73A	4	BDQ69	T
GNDIO	GNDIO4	-		
AG21	PB73B	4	BDQ69	C
AG18	PB74A	4	BDQ78	T
AJ16	PB74B	4	BDQ78	C
AF21	PB75A	4	BDQ78	T
AG22	PB75B	4	BDQ78	C
AD17	PB76A	4	BDQ78	T
AF19	PB76B	4	BDQ78	C
VCCIO	VCCIO4	4		
GNDIO	GNDIO4	-		
AH17	PB80A	4	BDQ78	T
AJ17	PB80B	4	BDQ78	C
VCCIO	VCCIO4	4		
AF26	PB82A	4	BDQ78	T
AE25	PB82B	4	BDQ78	C
GNDIO	GNDIO4	-		
AD24	PB92A	4	BDQ96	T
AE24	PB92B	4	BDQ96	C
AD18	PB93A	4	BDQ96	T
AC18	PB93B	4	BDQ96	C
AE18	PB94A	4	BDQ96	T
AG19	PB94B	4	BDQ96	C
VCCIO	VCCIO4	4		
GNDIO	GNDIO4	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
M10	VCCIO7	7		
M7	VCCIO7	7		
N10	VCCIO7	7		
N3	VCCIO7	7		
P10	VCCIO7	7		
R6	VCCIO7	7		
AA25	VCCIO8	8		
AD28	VCCIO8	8		
AA10	VCCAUX	-		
AA11	VCCAUX	-		
AA20	VCCAUX	-		
AA21	VCCAUX	-		
K10	VCCAUX	-		
K11	VCCAUX	-		
K20	VCCAUX	-		
K21	VCCAUX	-		
L10	VCCAUX	-		
L11	VCCAUX	-		
L20	VCCAUX	-		
L21	VCCAUX	-		
Y10	VCCAUX	-		
Y11	VCCAUX	-		
Y20	VCCAUX	-		
Y21	VCCAUX	-		
A1	GND	-		
A13	GND	-		
A18	GND	-		
A24	GND	-		
A30	GND	-		
A7	GND	-		
AA14	GND	-		
AA15	GND	-		
AA16	GND	-		
AA17	GND	-		
AA24	GND	-		
AA27	GND	-		
AA4	GND	-		
AB24	GND	-		
AB7	GND	-		
AD12	GND	-		
AD19	GND	-		
AD27	GND	-		
AE22	GND	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
M2	PL26A	7	LDQ28	T (LVDS)*	PL30A	7	LDQ32	T (LVDS)*
M1	PL26B	7	LDQ28	C (LVDS)*	PL30B	7	LDQ32	C (LVDS)*
L6	PL27A	7	LDQ28	T	PL31A	7	LDQ32	T
L5	PL27B	7	LDQ28	C	PL31B	7	LDQ32	C
GNDIO	GNDIO7	-			GNDIO7	-		
L3	PL28A	7	LDQS28	T (LVDS)*	PL32A	7	LDQS32	T (LVDS)*
L4	PL28B	7	LDQ28	C (LVDS)*	PL32B	7	LDQ32	C (LVDS)*
M3	PL29A	7	LDQ28	T	PL33A	7	LDQ32	T
VCCIO	VCCIO7	7			VCCIO7	7		
M4	PL29B	7	LDQ28	C	PL33B	7	LDQ32	C
N1	PL30A	7	LDQ28	T (LVDS)*	PL34A	7	LDQ32	T (LVDS)*
N2	PL30B	7	LDQ28	C (LVDS)*	PL34B	7	LDQ32	C (LVDS)*
M5	PL31A	7	LDQ28	T	PL35A	7	LDQ32	T
GNDIO	GNDIO7	-			GNDIO7	-		
N6	PL31B	7	LDQ28	C	PL35B	7	LDQ32	C
P3	NC	-			PL37A	7		T (LVDS)*
-	-	-			GNDIO7	-		
P4	NC	-			PL37B	7		C (LVDS)*
P9	NC	-			PL38A	7		T
M7	NC	-			PL38B	7		C
-	-	-			VCCIO7	7		
P1	NC	-			PL39A	7		T (LVDS)*
P2	NC	-			PL39B	7		C (LVDS)*
N7	NC	-			PL40A	7		T
P7	NC	-			PL40B	7		C
-	-	-			GNDIO7	-		
P5	PL33A	7	LDQ37	T (LVDS)*	PL41A	7	LDQ45	T (LVDS)*
N5	PL33B	7	LDQ37	C (LVDS)*	PL41B	7	LDQ45	C (LVDS)*
P8	PL34A	7	LDQ37	T	PL42A	7	LDQ45	T
P6	PL34B	7	LDQ37	C	PL42B	7	LDQ45	C
VCCIO	VCCIO7	7			VCCIO7	7		
R3	PL35A	7	LDQ37	T (LVDS)*	PL43A	7	LDQ45	T (LVDS)*
R4	PL35B	7	LDQ37	C (LVDS)*	PL43B	7	LDQ45	C (LVDS)*
R10	PL36A	7	LDQ37	T	PL44A	7	LDQ45	T
P11	PL36B	7	LDQ37	C	PL44B	7	LDQ45	C
GNDIO	GNDIO7	-			GNDIO7	-		
R7	PL37A	7	LDQS37	T (LVDS)*	PL45A	7	LDQS45	T (LVDS)*
R8	PL37B	7	LDQ37	C (LVDS)*	PL45B	7	LDQ45	C (LVDS)*
R5	PL38A	7	LDQ37	T	PL46A	7	LDQ45	T
VCCIO	VCCIO7	7			VCCIO7	7		
T5	PL38B	7	LDQ37	C	PL46B	7	LDQ45	C
R1	PL39A	7	LDQ37	T (LVDS)*	PL47A	7	LDQ45	T (LVDS)*
R2	PL39B	7	LDQ37	C (LVDS)*	PL47B	7	LDQ45	C (LVDS)*
R11	PL40A	7	LDQ37	T	PL48A	7	LDQ45	T
GNDIO	GNDIO7	-			GNDIO7	-		
T10	PL40B	7	LDQ37	C	PL48B	7	LDQ45	C
T1	PL42A	7	LUM3_SPLLT_IN_A/LDQ46	T (LVDS)*	PL50A	7	LUM3_SPLLT_IN_A/LDQ54	T (LVDS)*
T2	PL42B	7	LUM3_SPLLC_IN_A/LDQ46	C (LVDS)*	PL50B	7	LUM3_SPLLC_IN_A/LDQ54	C (LVDS)*
U10	PL43A	7	LUM3_SPLLT_FB_A/LDQ46	T	PL51A	7	LUM3_SPLLT_FB_A/LDQ54	T

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
E5	ULC_SQ_REFCLKN	11		C	ULC_SQ_REFCLKN	11		C
D5	ULC_SQ_REFCLKP	11		T	ULC_SQ_REFCLKP	11		T
D6	ULC_SQ_VCCP	11			ULC_SQ_VCCP	11		
C5	ULC_SQ_HDINP2	11		T	ULC_SQ_HDINP2	11		T
D4	ULC_SQ_VCCIB2	11			ULC_SQ_VCCIB2	11		
C4	ULC_SQ_HDINN2	11		C	ULC_SQ_HDINN2	11		C
B5	ULC_SQ_VCCRX2	11			ULC_SQ_VCCRX2	11		
A5	ULC_SQ_HDOUTP2	11		T	ULC_SQ_HDOUTP2	11		T
D3	ULC_SQ_VCCOB2	11			ULC_SQ_VCCOB2	11		
A4	ULC_SQ_HDOUTN2	11		C	ULC_SQ_HDOUTN2	11		C
B4	ULC_SQ_VCCTX2	11			ULC_SQ_VCCTX2	11		
A3	ULC_SQ_HDOUTN3	11		C	ULC_SQ_HDOUTN3	11		C
C1	ULC_SQ_VCCOB3	11			ULC_SQ_VCCOB3	11		
A2	ULC_SQ_HDOUTP3	11		T	ULC_SQ_HDOUTP3	11		T
B3	ULC_SQ_VCCTX3	11			ULC_SQ_VCCTX3	11		
C3	ULC_SQ_HDINN3	11		C	ULC_SQ_HDINN3	11		C
B1	ULC_SQ_VCCIB3	11			ULC_SQ_VCCIB3	11		
C2	ULC_SQ_HDINP3	11		T	ULC_SQ_HDINP3	11		T
B2	ULC_SQ_VCCRX3	11			ULC_SQ_VCCRX3	11		
AA13	VCC	-			VCC	-		
AA14	VCC	-			VCC	-		
AA15	VCC	-			VCC	-		
AA16	VCC	-			VCC	-		
AA17	VCC	-			VCC	-		
AA18	VCC	-			VCC	-		
AA19	VCC	-			VCC	-		
AA20	VCC	-			VCC	-		
AA21	VCC	-			VCC	-		
AA22	VCC	-			VCC	-		
AB14	VCC	-			VCC	-		
AB15	VCC	-			VCC	-		
AB20	VCC	-			VCC	-		
AB21	VCC	-			VCC	-		
N14	VCC	-			VCC	-		
N15	VCC	-			VCC	-		
N20	VCC	-			VCC	-		
N21	VCC	-			VCC	-		
P13	VCC	-			VCC	-		
P14	VCC	-			VCC	-		
P15	VCC	-			VCC	-		
P16	VCC	-			VCC	-		
P17	VCC	-			VCC	-		
P18	VCC	-			VCC	-		
P19	VCC	-			VCC	-		
P20	VCC	-			VCC	-		
P21	VCC	-			VCC	-		
P22	VCC	-			VCC	-		
R13	VCC	-			VCC	-		
R14	VCC	-			VCC	-		

LatticeECP2 S-Series Devices, Conventional Packaging

Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6SE-5T144C	90	1.2V	-5	TQFP	144	Com	6
LFE2-6SE-6T144C	90	1.2V	-6	TQFP	144	Com	6
LFE2-6SE-7T144C	90	1.2V	-7	TQFP	144	Com	6
LFE2-6SE-5F256C	190	1.2V	-5	fpBGA	256	Com	6
LFE2-6SE-6F256C	190	1.2V	-6	fpBGA	256	Com	6
LFE2-6SE-7F256C	190	1.2V	-7	fpBGA	256	Com	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12SE-5T144C	93	1.2V	-5	TQFP	144	Com	12
LFE2-12SE-6T144C	93	1.2V	-6	TQFP	144	Com	12
LFE2-12SE-7T144C	93	1.2V	-7	TQFP	144	Com	12
LFE2-12SE-5Q208C	131	1.2V	-5	PQFP	208	Com	12
LFE2-12SE-6Q208C	131	1.2V	-6	PQFP	208	Com	12
LFE2-12SE-7Q208C	131	1.2V	-7	PQFP	208	Com	12
LFE2-12SE-5F256C	193	1.2V	-5	fpBGA	256	Com	12
LFE2-12SE-6F256C	193	1.2V	-6	fpBGA	256	Com	12
LFE2-12SE-7F256C	193	1.2V	-7	fpBGA	256	Com	12
LFE2-12SE-5F484C	297	1.2V	-5	fpBGA	484	Com	12
LFE2-12SE-6F484C	297	1.2V	-6	fpBGA	484	Com	12
LFE2-12SE-7F484C	297	1.2V	-7	fpBGA	484	Com	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20SE-5Q208C	131	1.2V	-5	PQFP	208	Com	20
LFE2-20SE-6Q208C	131	1.2V	-6	PQFP	208	Com	20
LFE2-20SE-7Q208C	131	1.2V	-7	PQFP	208	Com	20
LFE2-20SE-5F256C	193	1.2V	-5	fpBGA	256	Com	20
LFE2-20SE-6F256C	193	1.2V	-6	fpBGA	256	Com	20
LFE2-20SE-7F256C	193	1.2V	-7	fpBGA	256	Com	20
LFE2-20SE-5F484C	331	1.2V	-5	fpBGA	484	Com	20
LFE2-20SE-6F484C	331	1.2V	-6	fpBGA	484	Com	20
LFE2-20SE-7F484C	331	1.2V	-7	fpBGA	484	Com	20
LFE2-20SE-5F672C	402	1.2V	-5	fpBGA	672	Com	20
LFE2-20SE-6F672C	402	1.2V	-6	fpBGA	672	Com	20
LFE2-20SE-7F672C	402	1.2V	-7	fpBGA	672	Com	20